ABSOLUTE MAXIMUM RATINGS (Note 1)

Supply Voltage (V _{CC})
V ⁻ (Note 7)13.2V
Input Voltage
Driver V^- to V^+
Receiver30V to 30V
On/Off Pin0.3V to 12V
Driver Disable Pin $-0.3V$ to (V _{CC} + 0.3V)
Output Voltage
Driver – 30V to 30V
Receiver $-0.3V$ to (V _{CC} + 0.3V)

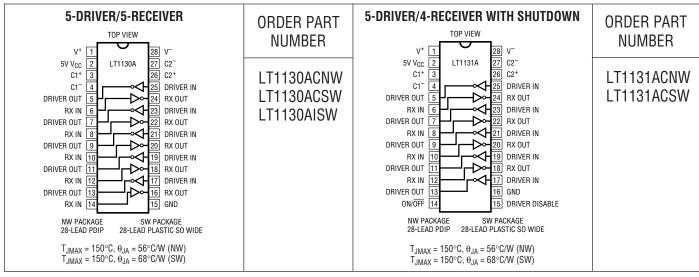
Short-Circuit Duration	
V+	30 sec
V ⁻	30 sec
Driver Output	Indefinite
Receiver Output	Indefinite
Operating Temperature Range	
LT113XAC/LT114XAC	0°C to 70°C
LT113XAI/LT114XAI	−40° to 85°C
Storage Temperature Range	-65°C to 150°C
Lead Temperature (Soldering, 10 sec).	300°C

PRODUCT SELECTION TABLE

Part Number	Power Supply Voltages*	Shutdown	Driver Disable	Drivers	Receivers	External Components	
LT1130A	5	No	No	5	5	4 Capacitors	
LT1131A	5	Yes	Yes	5	4	4 Capacitors	
LT1132A	5	No	No	5	3	4 Capacitors	
LT1133A**	5	No	No	3	5	4 Capacitors	
LT1134A	5	No	No	4	4	4 Capacitors	
LT1135A	5, 12, -12	No	No	5	3	None	
LT1136A	5	Yes	Yes	4	5	4 Capacitors	
LT1137A**	5	Yes	Yes	3	5	4 Capacitors	
LT1138A	5	Yes	Yes	5	3	4 Capacitors	
LT1139A	5, 12	Yes	No	4	4	2 Capacitors	
LT1140A	5, 12, -12	Yes	Yes	5	3	None	
LT1141A**	5, 12, –12	Yes	Yes	3	5	None	

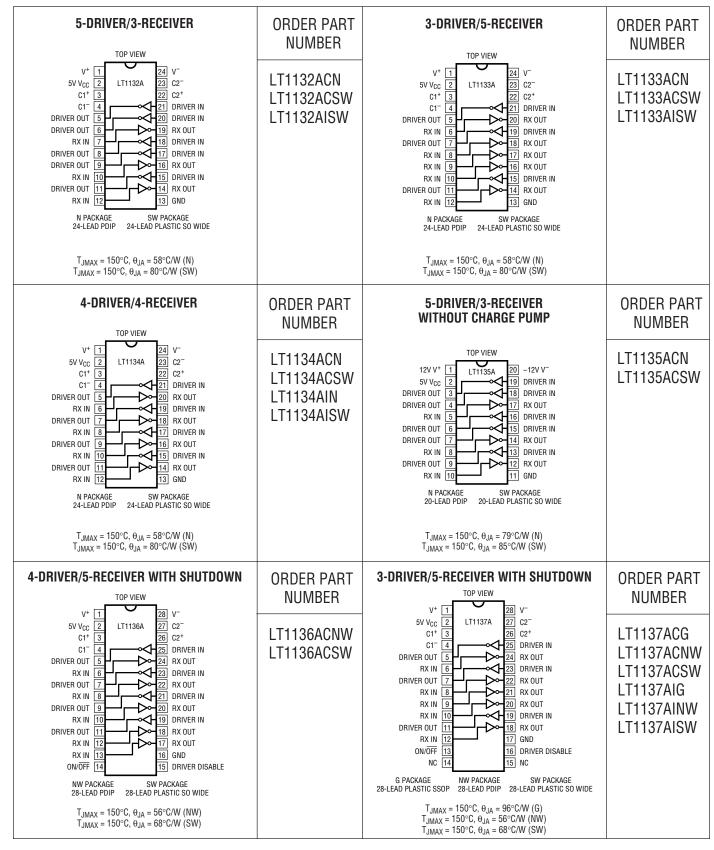
*The LT1130A, LT1131A, LT1132A, LT1134A, LT1136A, LT1137A and LT1138A can operate with 5V and 12V supplies and two external capacitors. **Meets ±15kV ESD air gap discharge and ±8kV contact methods per IEC-1000-4-2.

PACKAGE/ORDER INFORMATION

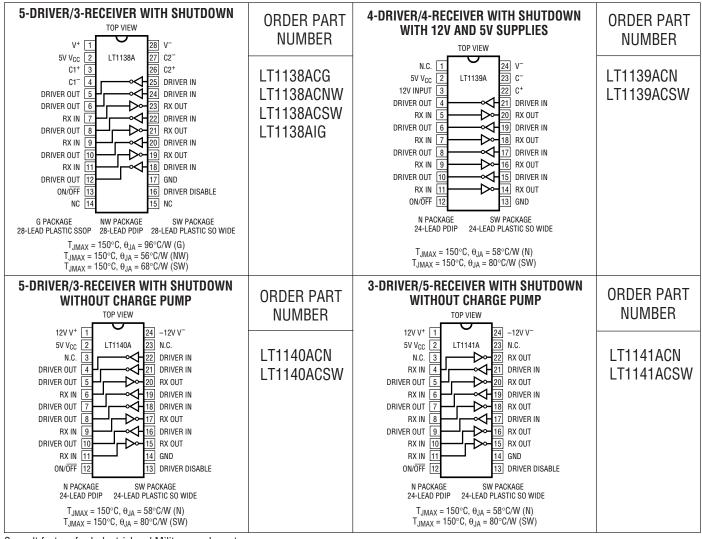




PACKAGE/ORDER INFORMATION



PACKAGE/ORDER INFORMATION



Consult factory for Industrial and Military grade parts.

ELECTRICAL CHARACTERISTICS The \bullet denotes the specifications which apply over the full operating temperature range, otherwise specifications are at T_A = 25°C. (Note 2)

PARAMETER	CONDITIONS		MIN	ТҮР	MAX	UNITS
Power Supply Generator						
V ⁺ Output				8.6		V
V ⁻ Output				-7.8		V
5V V _{CC} Supply Current: LT1130A, LT1131A, LT1132A, LT1133A, LT1134A, LT1136A, LT1138A	(Note 3)	•		15	25	mA
5V V _{CC} Supply Current: LT1135A, LT1140A, LT1141A	(Note 3), V ⁺ = 12V, V ⁻ = -12V	•		8	15	mA
5V V _{CC} Supply Current: LT1137A	(Note 3)	•		12	17	mA
5V V _{CC} Supply Current: LT1139A	(Note 3), V ⁺ = 12V			8	15	mA
12V V ⁺ Supply Current: LT1135A, LT1140A, LT1141A	(Note 3), V ⁻ = -12V	•		1	4	mA
12V V ⁺ Supply Current: LT1139A	(Note 3)	•		6	10	mA
–12V V [–] Supply Current: LT1135A, LT1140A, LT1141A	(Note 3) V ⁺ = 12V			2	6	mA



ELECTRICAL CHARACTERISTICS The \bullet denotes the specifications which apply over the full operating temperature range, otherwise specifications are at T_A = 25°C. (Note 2)

PARAMETER	CONDITIONS		MIN	ТҮР	MAX	UNITS
Supply Current when OFF (V _{CC})	Shutdown (Note 4) Driver Disable	•		1 4	10	μA mA
Supply Rise Time Shutdown to Turn-On	C1, C2, C ⁺ , C ⁻ = 1.0μF C ⁺ , C ⁻ = 0.1μF, C1, C2 = 0.2μF			2.0 0.2		ms ms
ON/OFF Pin Thresholds	Input Low Level (Device Shut Down) Input High Level (Device Enabled)	•	2.4	1.4 1.4	0.8	V V
ON/OFF Pin Current	$0V \le V_{ON/OFF} \le 5V$	•	-15		80	μA
DRIVER DISABLE Pin Thresholds	Input Low Level (Drivers Enabled) Input High Level (Drivers Disabled)	•	2.4	1.4 1.4	0.8	V V
DRIVER DISABLE Pin Current	$0V \le V_{DRIVER DISABLE} \le 5V$		-10		500	μA
Oscillator Frequency				130		kHz
Any Driver						
Output Voltage Swing	Load = 3k to GND Positive Negative	•	5	7.3 -6.5	-5	V V
Logic Input Voltage Level	Input Low Level (V _{OUT} = High) Input High Level (V _{OUT} = Low)	Input Low Level (V _{OUT} = High) Input High Level (V _{OUT} = Low)		1.4 1.4	0.8	V V
Logic Input Current	$0.8V \le V_{IN} \le 2V$	•		5	20	μA
Output Short-Circuit Current	V _{OUT} = 0V		±9	±17		mA
Output Leakage Current	Shutdown $V_{OUT} = \pm 30V$ (Note 4)	•		10	100	μA
Data Rate	$ \begin{array}{l} R_L = 3k, \ C_L = 2500 p F \\ R_L = 3k, \ C_L = 1000 p F \end{array} $		120 250			kbaud kbaud
Slew Rate	$R_L = 3k, C_L = 51pF$ $R_L = 3k, C_L = 2500pF$ (Note 8)			15 6	30	V/µs V/µs
Propagation Delay	Output Transition t_{HL} High to Low (Note 5) Output Transition t_{LH} Low to High	Output Transition t _{HL} High to Low (Note 5) Output Transition t _{LH} Low to High		0.6 0.5	1.3 1.3	μs μs
Any Receiver						
Input Voltage Thresholds	Input Low Threshold (V _{OUT} = High) Input High Threshold (V _{OUT} = Low)	•	0.8	1.3 1.7	2.4	V V
Hysteresis		•	0.1	0.4	1	V
Input Resistance	-10V < V _{IN} < 10V	-10V < V _{IN} < 10V		5	7	kΩ
Output Voltage	Output Low, I _{OUT} = -1.6mA Output High, I _{OUT} = 160μA (V _{CC} = 5V)	•	3.5	0.2 4.2	0.4	V V
Output Leakage Current	Shutdown (Note 4) $0 \le V_{OUT} \le V_{CC}$	Shutdown (Note 4) $0 \le V_{OUT} \le V_{CC}$ • 1 1		10	μA	
Output Short-Circuit Current	Sinking Current, V _{OUT} = V _{CC} Sourcing Current, V _{OUT} = 0V	Sinking Current, $V_{OUT} = V_{CC}$ -20 -10 Sourcing Current, $V_{OUT} = 0V$ 1020		-10	mA mA	
Propagation Delay	Output Transition t _{HL} High to Low (Note 6) Output Transition t _{LH} Low to High			250 350	600 600	ns ns

Note 1: Absolute Maximum Ratings are those values beyond which the life of the device may be impaired.

Note 2: Testing done at $V_{CC} = 5V$ and $V_{ON/OFF} = 3V$.

Note 3: Supply current is measured with driver and receiver outputs unloaded and the driver inputs tied high.

Note 4: Supply current and driver leakage current measurements in shutdown are performed with $V_{ON/OFF} = 0.1V$. Supply current measurements using DRIVER DISABLE are performed with VDRIVER DISABLE = 3V. For LT1135, LT1139, LT1140 and LT1141 with 12V supplies, V_{OUT} leakage is 200 μ A for V_{OUT} forced to ±25V.

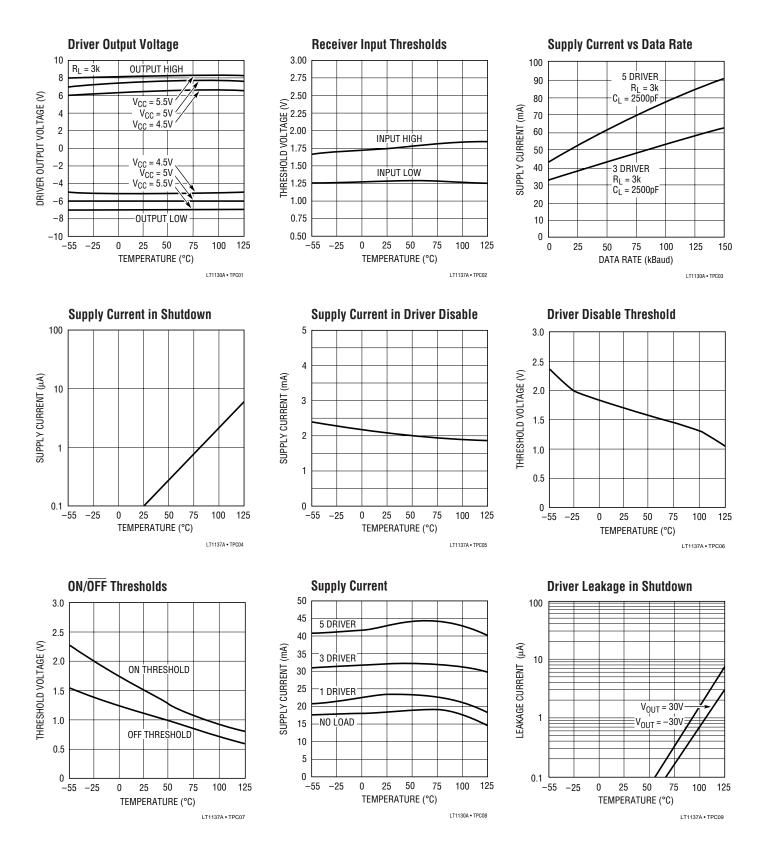
Note 5: For driver delay measurements, $R_L = 3k$ and $C_L = 51pF$. Trigger points are set between the driver's input logic threshold and the output transition to the zero crossing (t_{HL} = 1.4V to 0V and t_{LH} = 1.4V to 0V). Note 6: For receiver delay measurements, $C_L = 51 pF$. Trigger points are set between the receiver's input logic threshold and the output transition to standard TTL/CMOS logic threshold (t_{HL} = 1.3V to 2.4V and $t_{LH} = 1.7V$ to 0.8V).

Note 7: For LT1133A/LT1137A, absolute maximum externally applied $V^{-} = -6.5V$. Internal charge pump will drive this pin to a higher negative voltage.

Note 8: For LT1137A, 4V/µs minimum.

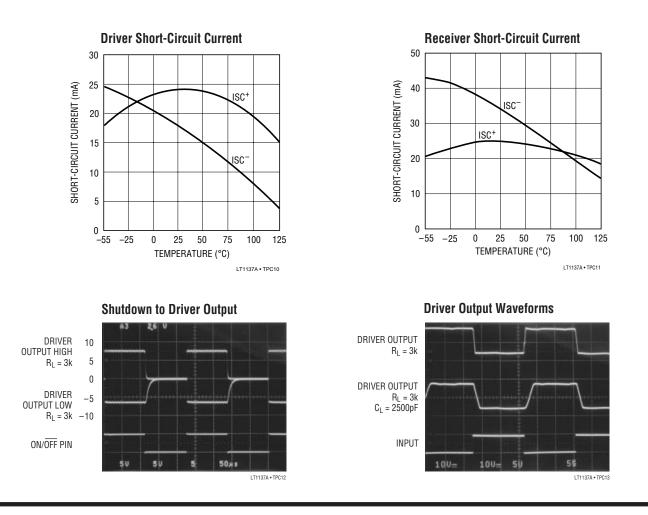


TYPICAL PERFORMANCE CHARACTERISTICS





TYPICAL PERFORMANCE CHARACTERISTICS



PIN FUNCTIONS

 V_{CC} : 5V Input Supply Pin. Supply current drops to zero in the shutdown mode. This pin should be decoupled with a 0.1µF ceramic capacitor close to the package pin. Insufficient supply bypassing can result in low output drive levels and erratic charge pump operation.

GND: Ground Pin.

ON/OFF: Control the operation mode of the device and is TTL/CMOS compatible. A logic low puts the device in the shutdown mode which reduces input supply curent to zero and places all of the drivers and receivers in high impedance state. A logic high fully enables the transceiver.

DRIVER DISABLE: This pin provides an alternate control for the charge pump and RS232 drivers. A logic high on this pin shuts down the charge pump and places all drivers

in a high impedance state. Receivers remain active under these conditions. Floating the DRIVER DISABLE pin or driving it to a logic low level fully enables the transceiver. A logic low on the ON/OFF pin supersedes the state of the DRIVER DISABLE pin. Supply current drops to 4mA when in driver disable mode.

V⁺: Positive Supply Output (RS232 Drivers). V⁺ \approx 2V_{CC} – 1.5V. This pin requires an external charge storage capacitor C \geq 1.0µF, tied to ground or V_{CC}. Larger value capacitors may be used to reduce supply ripple. With multiple transceivers, the V⁺ and V⁻ pins may be paralleled into common capacitors. For large numbers of transceivers, increasing the size of the shared common storage capacitors is recommended to reduce ripple.



PIN FUNCTIONS

V⁻: Negative Supply Output (RS232 Drivers). V⁻ \approx -(2V_{CC} - 2.5V). This pin requires an external charge storage capacitor C \geq 0.1µF. V⁻ is short-circuit proof for 30 seconds.

C1+, C1-, C2+, C2-: Commutating Capacitor Inputs. These pins require two external capacitors $C \ge 0.2\mu$ F: one from C1+ to C1-, and another from C2+ to C2-. To maintain charge pump efficiency, the capacitor's effective series resistance should be less than 2Ω . For $C \ge 1\mu$ F, low ESR tantalum capacitors work well in this application, although small value ceramic capacitors may be used with a minimal reduction in charge pump compliance. In applications where larger positive voltages are available, such as 12V, C1 may be omitted and the positive voltage may be connected directly to the C1+ pin. In this mode of operation, the V+ pin should be decoupled with a 0.1 μ F ceramic capacitor.

DRIVER IN: RS232 Driver Input Pins. These inputs are TTL/CMOS compatible. Inputs should not be allowed to float. Tie unused inputs to V_{CC} .

DRIVER OUT: Driver Outputs at RS232 Voltage Levels. Driver output swing meets RS232 levels for loads up to 3k.

Slew rates are controlled for lightly loaded lines. Output current capability is sufficient for load conditions up to 2500pF. Outputs are in a high impedance state when in shutdown mode, $V_{CC} = 0V$, or when the DRIVER DISABLE pin is active. Outputs are fully short-circuit protected from $V^- + 30V$ to $V^+ - 30V$. Applying higher voltages will not damage the device if the overdrive is moderately current limited. Short circuits on one output can load the power supply generator and may disrupt the signal levels of the other outputs. The driver outputs are protected against ESD to $\pm 10kV$ for human body model discharges.

RX IN: Receiver Inputs. These pins accept RS232 level signals (\pm 30V) into a protected 5k terminating resistor. The receiver inputs are protected against ESD to \pm 10kV for human body model discharges. Each receiver provides 0.4V of hysteresis for noise immunity. Open receiver inputs assume a logic low state.

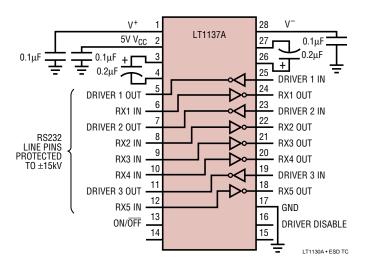
RX OUT: Receiver Outputs with TTL/CMOS Voltage Levels. Outputs are in a high impedance state when in shutdown mode to allow data line sharing. Outputs are fully short-circuit protected to ground or V_{CC} with the power on, off, or in shutdown mode.

ESD PROTECTION

The RS232 line inputs of the LT1130A/LT1140A series of RS232 Driver/Receivers have on-chip protection from ESD transients up to \pm 10kV. The protection structures act to divert the static discharge safely to system ground. In order for the ESD protection to function effectively, the power supply and ground pins of the LT1130A/LT1140A must be connected to ground through low impedances. The power supply decoupling capacitors and charge pump storage capacitors provide this low impedance in normal application of the circuit. The only constraint is that low ESR capacitors must be used for bypassing and charge storage. ESD testing must be done with pins V_{CC}, V⁺, V⁻ and GND shorted to ground or connected with low ESR capacitors.

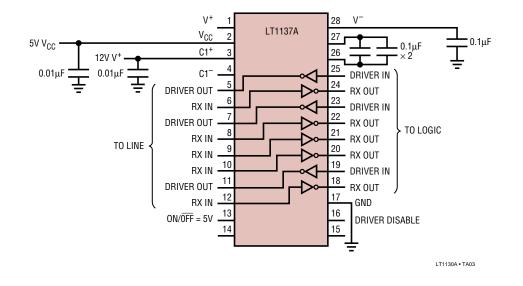
The ESD protection on the LT1133A, LT1137A and LT1141A meets \pm 15kV air gap discharge and \pm 8kV contact methods per IEC-1000-4-2.

ESD Test Circuit



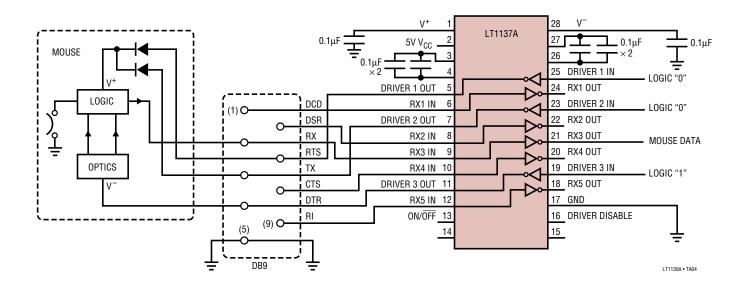


TYPICAL APPLICATIONS



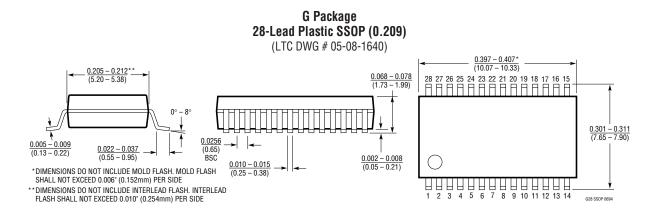
Operation Using 5V and 12V Power Supplies



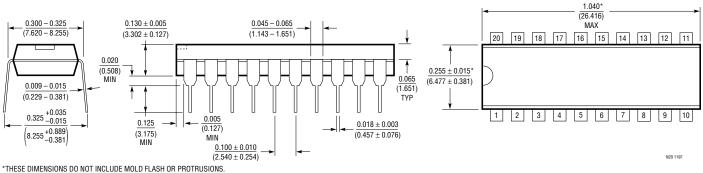




PACKAGE DESCRIPTION Dimensions in inches (millimeters) unless otherwise noted.

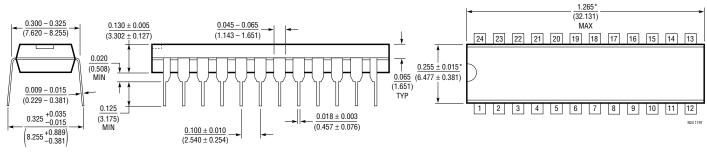


N Package 20-Lead PDIP (Narrow 0.300) (LTC DWG # 05-08-1510)



*THESE DIMENSIONS DO NOT INCLUDE MOLD FLASH OR PROTRUSIONS. MOLD FLASH OR PROTRUSIONS SHALL NOT EXCEED 0.010 INCH (0.254mm)





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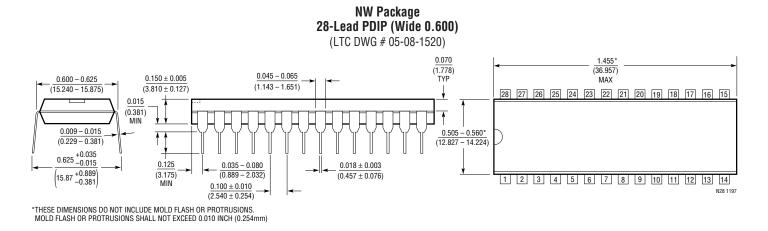


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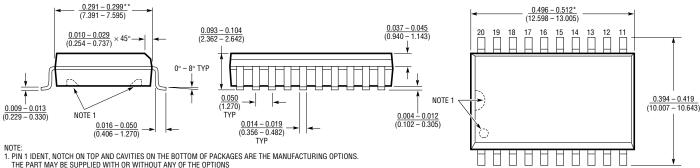
6 7 8 9 10

2 3 4

PACKAGE DESCRIPTION Dimensions in inches (millimeters) unless otherwise noted.



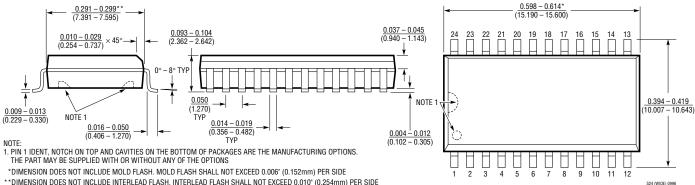
SW Package 20-Lead Plastic Small Outline (Wide 0.300) (LTC DWG # 05-08-1620)



*DIMENSION DOES NOT INCLUDE MOLD FLASH. MOLD FLASH SHALL NOT EXCEED 0.006" (0.152mm) PER SIDE

**DIMENSION DOES NOT INCLUDE INTERLEAD FLASH. INTERLEAD FLASH SHALL NOT EXCEED 0.010" (0.254mm) PER SIDE

SW Package 24-Lead Plastic Small Outline (Wide 0.300) (LTC DWG # 05-08-1620)

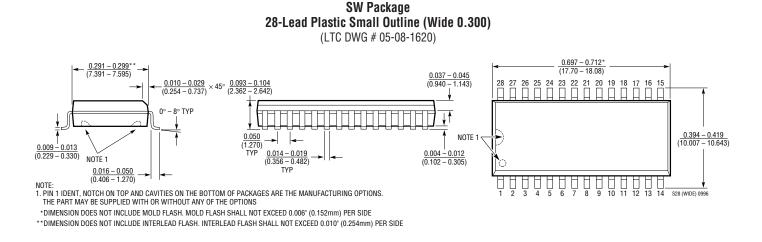


**DIMENSION DOES NOT INCLUDE INTERLEAD FLASH. INTERLEAD FLASH SHALL NOT EXCEED 0.010" (0.254mm) PER SIDE



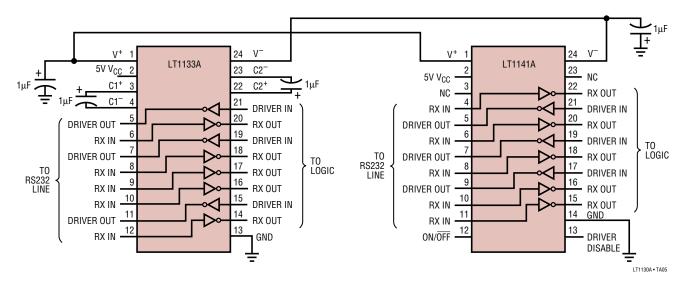
Information furnished by Linear Technology Corporation is believed to be accurate and reliable. However, no responsibility is assumed for its use. Linear Technology Corporation makes no representation that the interconnection of its circuits as described herein will not infringe on existing patent rights. S20 (WIDE) 0396

PACKAGE DESCRIPTION Dimensions in inches (millimeters) unless otherwise noted.



TYPICAL APPLICATION





RELATED PARTS

PART NUMBER	DESCRIPTION	COMMENTS
LT1180A/LT1181A	2-Driver/2-Receiver RS232 Transceivers	Single 5V Supply with 0.1 µF Capacitors
LT1237	3-Driver/5-Receiver RS232 Transceiver	Lower Power Upgrade for LT1137A
LTC1327	3-Driver/5-Receiver RS562 Transceiver	3.3V Operation
LTC1337	3-Driver/5-Receiver RS232 Transceiver	Ultralow Power for DTE Applications
LTC1338	5-Driver/3-Receiver RS232 Transceiver	Ultralow Power for DCE Applications
LTC1348	3-Driver/5-Receiver RS232 Transceiver	3.3V to 5V Operation